BC327, BC327-16, BC327-25, BC327-40

Amplifier Transistors PNP Silicon

Features

• Pb–Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector – Emitter Voltage	V _{CEO}	-45	Vdc
Collector-Base Voltage	V _{CES}	-50	Vdc
Collector – Emitter Voltage	V _{EBO}	-5.0	Vdc
Collector Current – Continuous	۱ _C	-800	mAdc
Total Power Dissipation @ $T_A = 25^{\circ}C$ Derate above $T_A = 25^{\circ}C$	P _D	625 5.0	mW mW/°C
Total Power Dissipation @ $T_A = 25^{\circ}C$ Derate above $T_A = 25^{\circ}C$	PD	1.5 12	W mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

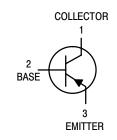
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	R_{\thetaJA}	200	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	83.3	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



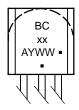
ON Semiconductor®

http://onsemi.com





MARKING DIAGRAM



BCxx = Device Code A = Assembly Location Y = Year WW = Work Week • = Pb-Free Package ote: Microdot may be in either location

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering, marking, and shipping information in the package dimensions section on page 4 of this data sheet.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

BC327, BC327-16, BC327-25, BC327-40

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector – Emitter Breakdown Voltage $(I_{C} = -10 \text{ mA}, I_{B} = 0)$		V _{(BR)CEO}	-45	_	-	Vdc
Collector – Emitter Breakdown Voltage $(I_C = -100 \ \mu A, I_E = 0)$		V _{(BR)CES}	-50	_	_	Vdc
Emitter – Base Breakdown Voltage $(I_E = -10 \ \mu A, I_C = 0)$		V _{(BR)EBO}	-5.0	-	-	Vdc
Collector Cutoff Current ($V_{CB} = -30 \text{ V}, I_E = 0$)		I _{CBO}	_	_	-100	nAdc
Collector Cutoff Current ($V_{CE} = -45 \text{ V}, V_{BE} = 0$)		I _{CES}	_	_	-100	nAdc
Emitter Cutoff Current ($V_{EB} = -4.0 \text{ V}, I_C = 0$)		I _{EBO}	_	-	-100	nAdc
ON CHARACTERISTICS						
DC Current Gain ($I_C = -100 \text{ mA}, V_{CE} = -1.0 \text{ V}$) ($I_C = -300 \text{ mA}, V_{CE} = -1.0 \text{ V}$)	BC327 BC327–16 BC327–25 BC327–40	h _{FE}	100 100 160 250 40	- - - -	630 250 400 630 -	-
Base–Emitter On Voltage ($I_C = -300$ mA, $V_{CE} = -1.0$ V)		V _{BE(on)}	-	-	-1.2	Vdc
Collector – Emitter Saturation Voltage $(I_C = -500 \text{ mA}, I_B = -50 \text{ mA})$		V _{CE(sat)}	-	-	-0.7	Vdc
SMALL-SIGNAL CHARACTERISTICS						
Output Capacitance $(V_{CB} = -10 \text{ V}, I_E = 0, f = 1.0 \text{ MHz})$		C _{ob}	_	11	-	pF
Current – Gain – Bandwidth Product ($I_C = -10$ mA, $V_{CE} = -5.0$ V, f = 100 MHz)		f _T	-	260	-	MHz

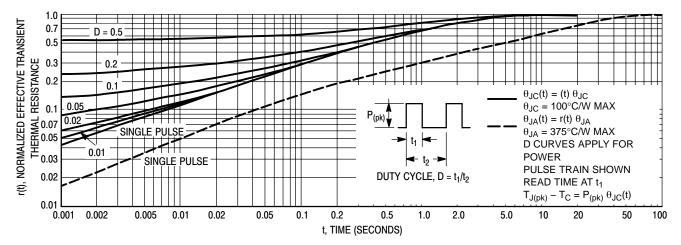


Figure 1. Thermal Response

BC327, BC327–16, BC327–25, BC327–40

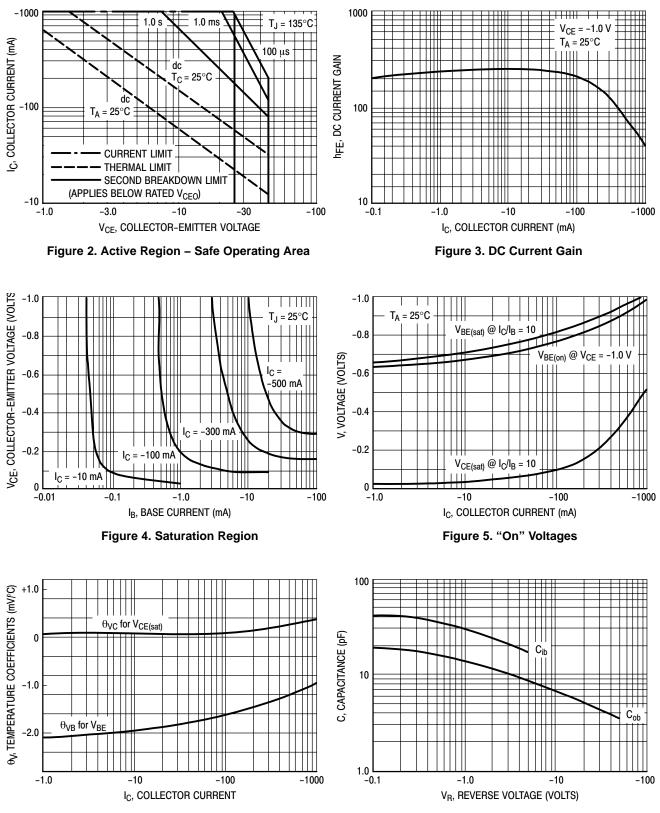




Figure 7. Capacitances

BC327, BC327–16, BC327–25, BC327–40

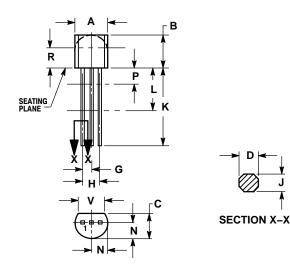
ORDERING INFORMATION

Device Order Number	Specific Device Marking	Package Type	Shipping [†]	
BC327	7	TO-92	5000 Units / Bulk	
BC327G	7	TO-92 (Pb-Free)	5000 Units / Bulk	
BC327RL1	327	TO-92	2000 / Tape & Reel	
BC327RL1G	327	TO-92 (Pb-Free)	2000 / Tape & Reel	
BC327ZL1	327	TO-92	2000 / Tape & Ammo Box	
BC327ZL1G	327	TO-92 (Pb-Free)	2000 / Tape & Ammo Box	
BC327-016	327	TO-92	5000 Units / Bulk	
BC327-016G	327	TO-92 (Pb-Free)	5000 Units / Bulk	
BC327-016ZL1	32716	TO-92	2000 / Tape & Ammo Box	
BC327-016ZL1G	32716	TO-92 (Pb-Free)	2000 / Tape & Ammo Box	
BC327-25RL1	7–25	TO-92	2000 / Tape & Reel	
BC327-25RL1G	7–25	TO-92 (Pb-Free)	2000 / Tape & Reel	
BC327-25ZL1	32725	TO-92	2000 / Tape & Ammo Box	
BC327-25ZL1G	32725	TO-92 (Pb-Free)	2000 / Tape & Ammo Box	
BC327-040	327	TO-92	2000 / Tape & Reel	
BC327-040G	327	TO-92 (Pb-Free)	2000 / Tape & Reel	
BC327-40ZL1	7–40	TO-92	2000 / Tape & Ammo Box	
BC327-40ZL1G	7–40	TO-92 (Pb-Free)	2000 / Tape & Ammo Box	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 **ISSUE AL**



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.

2.

CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED. 3. LEAD DIMENSION IS UNCONTROLLED IN P AND

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
Κ	0.500		12.70	
L	0.250		6.35	
Ν	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.115		2.93	
٧	0.135		3.43	

STYLE 17:

PIN 1. COLLECTOR BASE 2.

3. EMITTER

ON Semiconductor and 💷 are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor P.O. Box 61312, Phoenix, Arizona 85082-1312 USA Phone: 480-829-7710 or 800-344-3860 Toll Free USA/Canada Fax: 480-829-7709 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Japan: ON Semiconductor, Japan Customer Focus Center 2-9-1 Kamimeguro, Meguro-ku, Tokyo, Japan 153-0051 Phone: 81-3-5773-3850

ON Semiconductor Website: http://onsemi.com

Order Literature: http://www.onsemi.com/litorder

For additional information, please contact your local Sales Representative.